Ultra High Accuracy, Low Iq, 500 mA Low Dropout Regulator

NCP3334A



WDFN8
MT SUFFIX
CASE 511CF

The NCP3334A is a high performance, low dropout regulator with accuracy of ±0.9% over line and load. This device features ultra−low quiescent current and noise which encompasses all necessary characteristics demanded by today's consumer electronics. This unique device is guaranteed to be stable without a minimum load current requirement and stable with any type of capacitor as small as 1.0 μF. The NCP3334A offers reverse bias protection. The device is available in a small 3x3 mm WDFN8 package.

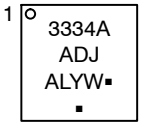
Features

- High Accuracy Over Line and Load (±0.9% at 25°C)
- Ultra−Low Dropout Voltage at Full Load
- No Minimum Output Current Required for Stability
- Low Noise
- Low Shutdown Current
- Reverse Bias Protected
- 2.6 V to 12 V Supply Range
- Thermal Shutdown Protection
- Current Limitation
- Requires Only 1.0 μF Output Capacitance for Stability
- Stable with Any Type of Capacitor (including MLCC)
- These are Pb−Free Devices

Applications

- Telecom Applications
- Cellular Base Stations
- Camcoders and Cameras
- Networking Systems, DSL/Cable Modems
- Cable Set−Top Box
- MP3/CD Players
- DSP Supply
- Displays and Monitors

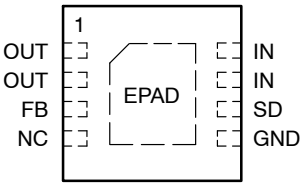
MARKING DIAGRAM



3334A	= Specific Device Code
A	= Assembly Location
L	= Wafer Lot
Y	= Year
W	= Work Week
▪	= Pb−Free Package

(Note: Microdot may be in either location)

PIN CONNECTIONS



(Top View)

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 7 of this data sheet.

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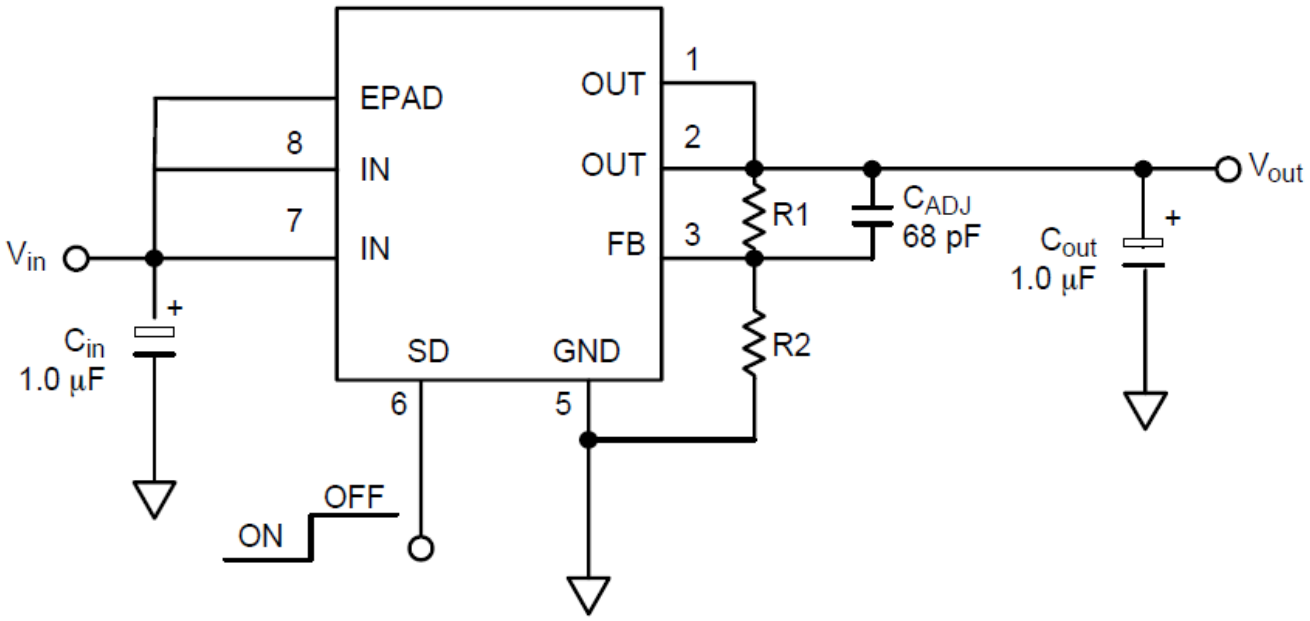


Figure 1. Typical Adjustable Version Application Schematic

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PIN FUNCTION DESCRIPTION

Pin No.	Pin Name	Description
1, 2	V_{out}	Regulated output voltage. Bypass to ground with $C_{out} \geq 1.0\ \mu F$.
3	FB	Adjustable pin; reference voltage = 1.178 V.
4	NC	Not Connected
5	GND	Power Supply Ground
6	SD	Shutdown pin. Pulling this pin Low turns on the regulator
7, 8	V_{in}	Power Supply Input Voltage
–	EPAD	Exposed thermal pad should be connected to ground or Vin. The EPAD is electrically isolated from the die.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage	V_{in}	−0.3 to +16	V
Output Voltage	V_{out}	−0.3 to V_{in} +0.3 or 10 V*	V
Shutdown Pin Voltage	V_{sh}	−0.3 to +16	V
Junction Temperature Range	T_J	−40 to +150	°C
Storage Temperature Range	T_{stg}	−65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
NOTE: This device series contains ESD protection and exceeds the following tests:
Human Body Model (HBM) JESD 22−A114−B
*Which ever is less. Reverse bias protection feature valid only if $V_{out} - V_{in} \leq 7$ V.

THERMAL CHARACTERISTICS

Characteristic	Test Conditions (Typical Value)		Unit
	Min Pad Board	1″ Pad Board (Note 1)	
WDFN 8			
Junction−to−Air, θJA	220	48	°C/W

1. As mounted on 4−Layer FR4 Substrate of a specified copper area of 2 oz copper traces in accordance with JEDEC 51.7.

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ELECTRICAL CHARACTERISTICS – Adjustable

(V_{out} = 1.178 V typical, V_{in} = 6.0 V, T_A = −40°C to +85°C, C_{in} = C_{out} = 1 μF, unless otherwise noted, Note 2, 3, 4)

Characteristic	Symbol	Min	Typ	Max	Unit
Reference Voltage Accuracy V_{in} = V_{outnom} + 0.4 V to 11 V, I_{load} = 0.1 mA to 500 mA, T_J = 25°C	V_{ref}	−0.9% 1.167	1.178	+0.9% 1.189	V
Reference Voltage Accuracy V_{in} = V_{outnom} + 0.4 V to 11 V, I_{load} = 0.1 mA to 500 mA, T_J = 85°C	V_{ref}	−1.4% 1.162	1.178	+1.4% 1.194	V
Reference Voltage Accuracy (Note 5) V_{in} = V_{outnom} + 0.4 V to 11 V, I_{load} = 0.1 mA to 500 mA, T_J = 150°C	V_{ref}	−1.5% 1.160	1.178	+1.5% 1.196	V
Line Regulation V_{in} = (V_{outnom} + 0.4 V) to 11 V, I_{load} = 0.1 mA, T_J = 25°C	$Line_{Reg}$		0.04		mV/V
Load Regulation I_{load} = 0.1 mA to 500 mA, T_J = 25°C	$Load_{Reg}$		0.04		mV/mA
Dropout Voltage, V_{out} = 98% of V_{outnom} I_{load} = 500 mA I_{load} = 300 mA I_{load} = 100 mA I_{load} = 1 mA	V_{DO}		 – – – 10	 340 230 140 –	mV
Peak Output Current (V_{in} = V_{outnom} + 1.0 V)	Ipk	500	700	860	mA
Thermal Shutdown	T_J		160		°C
Ground Current In Regulation I_{load} = 500 mA (Note 3) I_{load} = 300 mA (Note 3) I_{load} = 50 mA I_{load} = 0.1 mA In Dropout V_{in} = V_{out} −0.1 V, I_{load} = 0.1 mA In Shutdown V_{SD} = 6.0 V, V_{in} = 11 V	I_{GND} I_{GNDsh}		 6.0 3.5 0.7 130 – 8	 10 6 1.5 180 450 20	 mA μA μA μA
Output Noise I_{load} = 500 mA, f = 10 Hz to 100 kHz, C_{out} = 10 μF, C_{nr} = 10 nF I_{load} = 500 mA, f = 10 Hz to 100 kHz, C_{out} = 10 μF, C_{nr} = 0 nF	V_{noise}		 26 38		μVrms
Shutdown Threshold Voltage OFF Threshold Voltage ON	V_{THSD}	 2.0		 0.4	 V V
SD Input Current, V_{SD} = 0 V to 0.4 V or V_{SD} = 2.0 V to V_{in}	I_{SD}		1.2	3.0	μA
Output Current In Shutdown Mode, V_{SD} = 2.0 V, V_{in} = 11 V	I_{OSD}		0.07	1.0	μA
Reverse Bias Protection, Current Flowing from the Output Pin to GND (V_{in} = 0 V, V_{out_forced} = V_{out}(nom) ≤ 7 V) (Note 6)	I_{OUTR}		1.0		μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. All limits at temperature extremes are guaranteed via correlation using standard statistical quality control (SQC) methods.
3. Ambient temperature of 85°C corresponds to a junction temperature of 125°C under pulsed full load test conditions.
4. Application stable with no load.
5. V_{IN} = 2.6 V to11 V for $V_{OUT(NOM)}$ ≤ 2.2 V and T_J > 0°C, otherwise V_{IN} = 2.9 V to 11 V.
6. Reverse bias protection feature valid only if V_{out} − V_{in} ≤ 7 V.

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TYPICAL CHARACTERISTICS

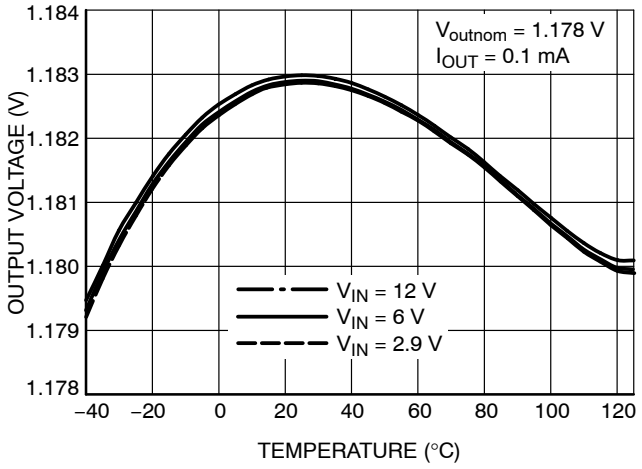


Figure 2. Output Voltage vs. Temperature

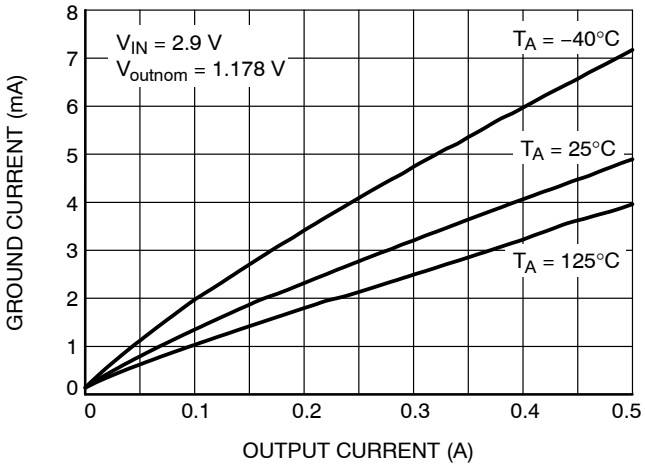


Figure 3. Ground Current vs. Output Current

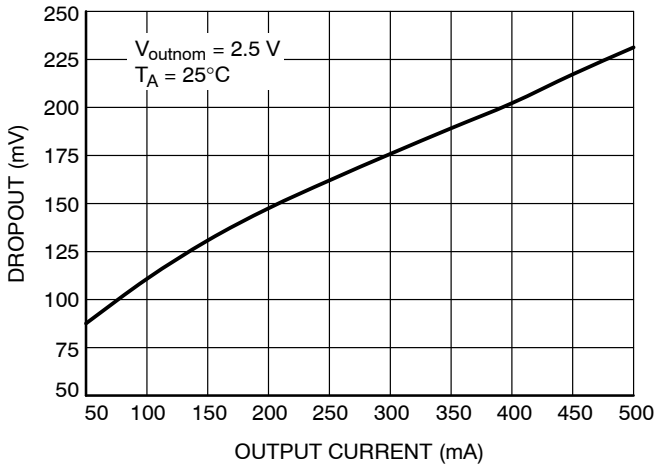


Figure 4. Dropout Voltage vs. Output Current

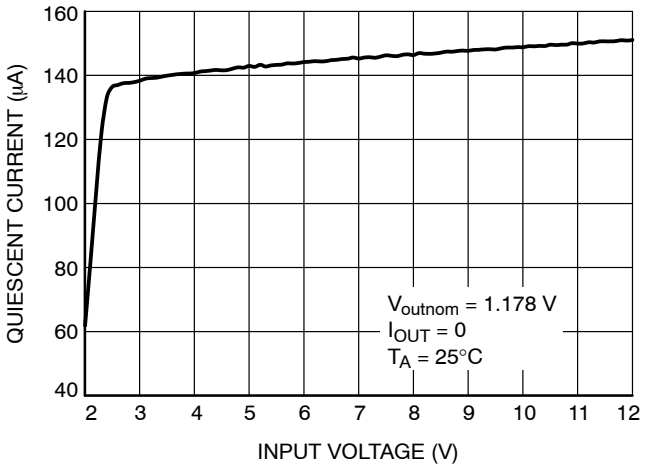


Figure 5. Quiescent Current vs. Input Voltage

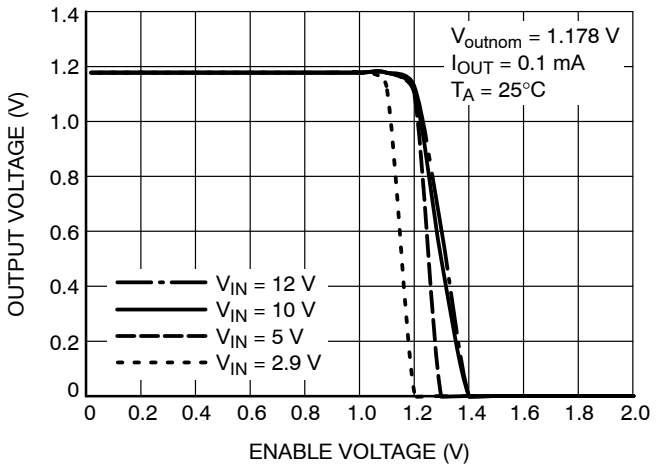


Figure 6. Enable OFF Threshold

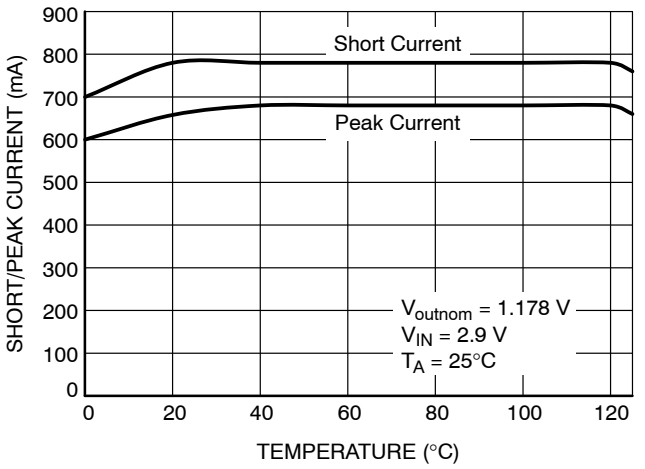


Figure 7. Peak and Short Current vs. Temperature

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TYPICAL CHARACTERISTICS

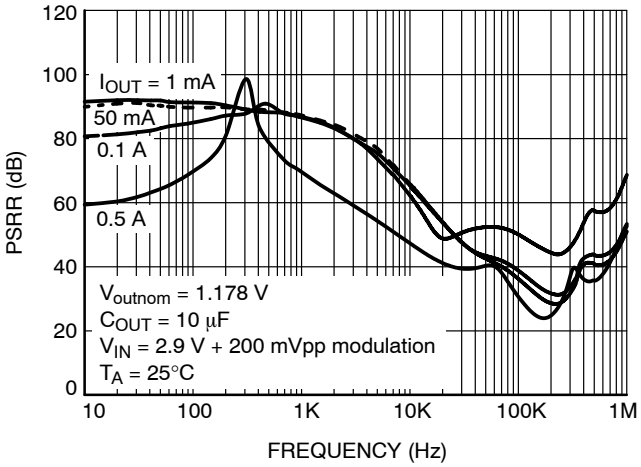


Figure 8. PSRR vs. Frequency

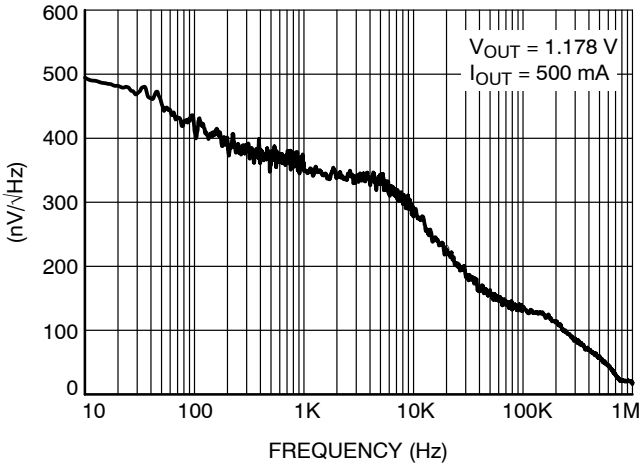


Figure 9. Output Noise Density

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APPLICATIONS INFORMATION

Reverse Bias Protection

Reverse bias is a condition caused when the input voltage goes to zero, but the output voltage is kept high either by a large output capacitor or another source in the application which feeds the output pin.

Normally in a bipolar LDO all the current will flow from the output pin to input pin through the PN junction with limited current capability and with the potential to destroy the IC.

Due to an improved architecture, the NCP3334A can withstand up to 7.0 V on the output pin with virtually no current flowing from output pin to input pin, and only negligible amount of current (tens of μA) flowing from the output pin to ground for infinite duration.

Input Capacitor

An input capacitor of at least 1.0 μF, any type, is recommended to improve the transient response of the regulator and/or if the regulator is located more than a few inches from the power source. It will also reduce the circuit's sensitivity to the input line impedance at high frequencies. The capacitor should be mounted with the shortest possible track length directly across the regular's input terminals.

Output Capacitor

The NCP3334A remains stable with any type of capacitor as long as it fulfills its 1.0 μF requirement. There are no constraints on the minimum ESR and it will remain stable up to an ESR of 5.0 Ω. Larger capacitor values will improve the noise rejection and load transient response.

Adjustable Operation

The output voltage can be set by using a resistor divider with a range of 1.178 to 10 V. The appropriate resistor divider can be found by solving the equation below. The recommended current through the resistor divider is from 10 μA to 100 μA. This can be accomplished by selecting resistors in the kΩ range. As result, the I_{adj}*R2 becomes negligible in the equation and can be ignored.

$$V_{out} = 1.178 * \left(1 + \frac{R1}{R2}\right) + I_{adj} * R2 \qquad \text{(eq. 1)}$$

Dropout Voltage

The voltage dropout is measured at 97% of the nominal output voltage.

Thermal Considerations

Internal thermal limiting circuitry is provided to protect the integrated circuit in the event that the maximum junction temperature is exceeded. This feature provides protection from a catastrophic device failure due to accidental overheating. This protection feature is not intended to be used as a substitute to heat sinking. The maximum power that can be dissipated, can be calculated with the equation below:

$$P_D = \frac{T_{J(max)} - T_A}{R_{\theta JA}} \qquad \text{(eq. 2)}$$

For improved thermal performance, contact the factory for the WDFN package option. The WDFN package includes an exposed metal pad that is specifically designed to reduce the junction to air thermal resistance, $R_{\theta JA}$.

ORDERING INFORMATION

Device	Nominal Output Voltage	Marking	Package	Shipping†
NCP3334AMTADJTBG	Adj.	3334A ADJ	WDFN8 (Pb−Free)	3000 / Tape & Reel

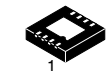
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*Please contact factory for other voltage options.

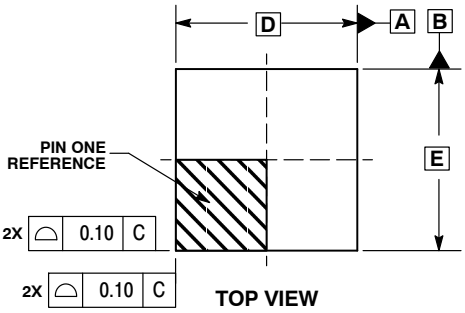
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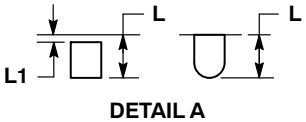
WDFN8 3x3, 0.5P
CASE 511CF
ISSUE O

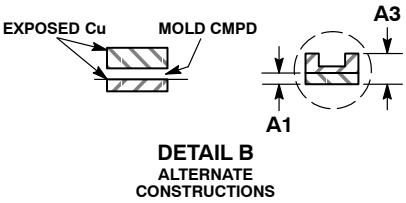
DATE 23 MAR 2015

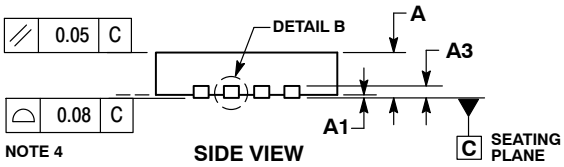


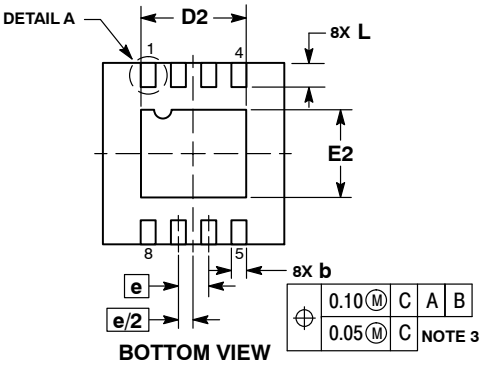
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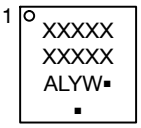




NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.05 AND 0.15 MM FROM TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
5. POSITIONAL TOLERANCE APPLIES TO ALL OF THE EXPOSED PADS.

	MILLIMETERS	
DIM	MIN	MAX
A	0.70	0.80
A1	0.00	0.05
A3	0.20 REF	
b	0.20	0.30
D	3.00 BSC	
D2	1.65	1.85
E	3.00 BSC	
E2	1.35	1.55
e	0.50 BSC	
L	0.30	0.50
L1	0.00	0.15

GENERIC MARKING DIAGRAM*

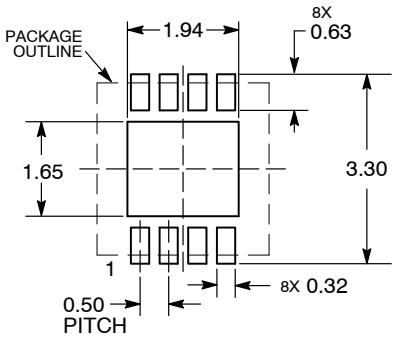


XXXXX = Specific Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb−Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking.
Pb−Free indicator, “G” or microdot “ ▪”, may or may not be present.

RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb−Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	**WDFN8, 3X3, 0.5P**		**PAGE 1 OF 1**

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For additional information, please contact your local Sales Representative at www.onsemi.com/support/sales

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Parça koduyla arama

Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

www.entegreci.com

Ürün kategorileri

Entegreden kapasitöre tüm elektronik komponent kategorileri.

Kategorilere göz atın

Üreticiler

Aradığınız üreticinin ürünlerini tek sayfada inceleyin.

Üreticileri görün

Toplu alım ve teklif

Listede olmayan ya da yüksek adetli parçalar için teklif isteyin.

Teklif isteyin

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Entegreci is an online electronic components store based in Türkiye. Search by manufacturer part number to see stock, prices and datasheets for integrated circuits, microcontrollers, transistors, passive components and connectors, or request a quote for parts that are not listed.

Bu sayfa Entegreci tarafından eklenmiştir. Belgenin önceki sayfaları asıl yayıncısına aittir ve içeriği değiştirilmemiştir; en güncel sürüm için belgenin yayıncısına başvurun.